

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Seiji NAGATANI

Group Art Unit: 1794

Serial No.: 10/593,152

Confirmation No. 7632

Filed : March 15, 2005

Examiner: Aaron S. Austin

For: **ELECTRODEPOSITED COPPER FOIL WITH CARRIER FOIL ON WHICH A RESIN LAYER FOR FORMING INSULATING LAYER IS FORMED, COPPER-CLAD LAMINATE, PRINTED WIRING BOARD, METHOD FOR MANUFACTURING MULTILAYER COPPER-CLAD LAMINATE, AND METHOD FOR MANUFACTURING PRINTED WIRING**

United States Patent and Trademark Office
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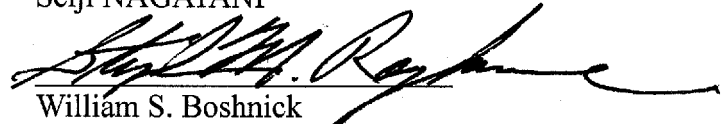
REQUEST FOR EXTENSION OF TIME

Sir:

Please extend the time for response to the Official Action dated August 4, 2009 by one month from November 4, 2009 to December 4, 2009. The amount of \$130.00 is submitted concurrently herewith as payment for the fee.

The U.S. Patent and Trademark Office is hereby authorized to credit any overpayment or charge any additional fee to Deposit Account No.19-0089.

Respectfully submitted,
Seiji NAGATANI


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